

Figure - 开发 Dev #113219

开发 Dev # 110122 (New): 【MK】管理总票
开发 Dev # 110125 (New): 【MK】【BSP】管理总票
开发 Dev # 110654 (进行中 In Progress): 【MK】【005】【LCD】主任务
【MK】【005】【LCD】【TC-RID: 1201-0100501】电气特性-GMSL支持热插拔、短接
2022-10-27 21:43 - CD BSP-唐金泽

Status:	完成 Closed	Start date:	2022-10-27
Priority:	Normal	Due date:	
Assignee:	CD BSP-余霄	% Done:	100%
Category:	BSP	Estimated time:	0.00 hour
Target version:			
Description			
电气特性-GMSL支持热插拔、短接 已完成，待测试验证			

History

#1 - 2022-10-27 21:44 - CD BSP-唐金泽

MCE_VX1上已完成，VC1上还未完成

#2 - 2022-11-08 16:26 - CD BSP-余霄

VC1热插拔显示、touch能自动恢复。
上电不插GMSL线，开机后插入恢复代码已合入：
<https://dev.thundercomm.com/gerrit/c/general/kernel/msm-4.19/+161710>

#3 - 2022-11-17 19:02 - CD BSP-余霄

VX1上电不插GMSL线，开机后插入恢复代码已合入：
<https://dev.thundercomm.com/gerrit/c/general/kernel/msm-4.19/+159208>

#4 - 2022-12-22 11:45 - CD BSP-余霄

- Status changed from 解决 Resolved to 完成 Closed